

N-Channel Power Trench[®] MOSFET 40V, 20A, 5.8m Ω

Features

- Max $r_{DS(on)} = 5.8 m\Omega$ at $V_{GS} = 10V$, $I_D = 13.5A$
- Max $r_{DS(on)} = 8.0 \text{m}\Omega$ at $V_{GS} = 4.5 \text{V}$, $I_D = 11.8 \text{A}$
- Low Profile 1mm max in Power 33
- 100% UIL Tested
- RoHS Compliant

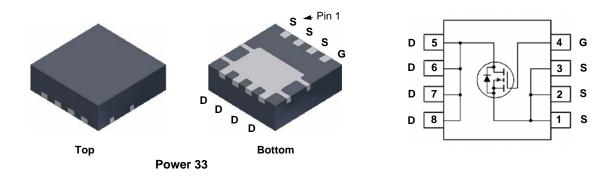


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

DC - DC Conversion



MOSFET Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			40	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous (Package limited)	T _C = 25°C		20		
	-Continuous (Silicon limited)	T _C = 25°C		64	٨	
	-Continuous	T _A = 25°C	(Note 1a)	14	A	
	-Pulsed			50		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	216	mJ	
P _D	Power Dissipation	$T_{C} = 25^{\circ}C$		41	14/	
	Power Dissipation $T_A = 25^{\circ}C$ (Note 1a)		(Note 1a)	2.0	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Ra	ange		-55 to +150	°C	

Thermal Characteristics

R_{\thetaJC}	Thermal Resistance, Junction to Case	3	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a	53	C/vv

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC8462	FDMC8462	Power 33	13"	12mm	3000 units

March 2008

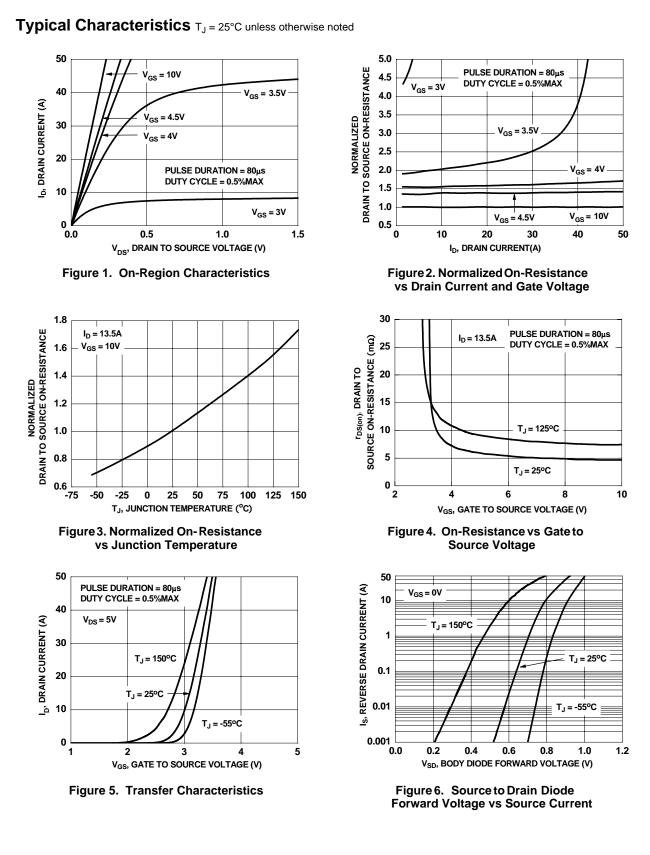
FDMC8462
N-Channel
Power
Trench®
MOSFET

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	Test Conditions	Min	Тур	Max	Units
teristics					
Drain to Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$	40			V
Breakdown Voltage Temperature Coefficient	$I_D = 250\mu$ A, referenced to 25°C	-	31		mV/°
Zero Gate Voltage Drain Current	$V_{GS} = 0V, V_{DS} = 32V,$			1	μA
				±100	nA
	00 00				
	$V_{22} = V_{22}$ $I_2 = 250 \mu A$	1.0	2.0	3.0	V
		1.0	2.0	0.0	v
Temperature Coefficient	$I_D = 250 \mu A$, referenced to $25^{\circ}C$		-6.6		mV/°
	V _{GS} = 10V, I _D = 13.5A		4.7	5.8	
Static Drain to Source On Resistance	V _{GS} = 4.5V, I _D = 11.8A		6.4	8.0	mΩ
	V _{GS} = 10V, I _D = 13.5A, T _J = 125°C		7.1	9.3	
Forward Transconductance	$V_{DD} = 5V, I_D = 13.5A$		60		S
Characteristics					
Input Capacitance			2000	2660	pF
Output Capacitance			545	725	pF
Reverse Transfer Capacitance			80	120	pF
Gate Resistance	f = 1MHz		2.7		Ω
Rise Time	$V_{DD} = 20V, I_D = 13.5A,$		4	10	ns
Turn-Off Delay Time	V_{GS} = 10V, R_{GEN} = 6 Ω		27	43	ns
Fall Time			3	10	ns
			v	10	
Total Gate Charge	$V_{GS} = 0V$ to 10V		30	43	nC
Total Gate Charge	$V_{GS} = 0V \text{ to } 4.5V$ $V_{DD} = 20V$,			-	
Total Gate Charge Gate to Source Charge			30	43	nC
Total Gate Charge	$V_{GS} = 0V \text{ to } 4.5V$ $V_{DD} = 20V$,		30 15	43	nC nC nC nC
Total Gate Charge Gate to Source Charge	$V_{GS} = 0V \text{ to } 4.5V$ $V_{DD} = 20V$,		30 15 6	43	nC nC
Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge rce Diode Characteristics	$V_{GS} = 0V \text{ to } 4.5V$ $V_{DD} = 20V,$ $I_D = 13.5A$ $V_{GS} = 0V, I_S = 13.5A$ (Note 2)		30 15 6	43	nC nC nC
Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{GS} = 0V \text{ to } 4.5V$ $V_{DD} = 20V,$ $I_D = 13.5A$		30 15 6 5	43 21	nC nC
Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge rce Diode Characteristics	$V_{GS} = 0V \text{ to } 4.5V$ $V_{DD} = 20V,$ $I_D = 13.5A$ $V_{GS} = 0V, I_S = 13.5A$ (Note 2)		30 15 6 5 0.8	43 21 1.3	nC nC nC
	Zero Gate Voltage Drain Current Gate to Source Leakage Current teristics Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient Static Drain to Source On Resistance Forward Transconductance Forward Transconductance Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time	CoolinitientVGS = 0V, VDS = 32V,Zero Gate Voltage Drain Current $V_{GS} = 0V, V_{DS} = 32V,$ Gate to Source Leakage Current $V_{GS} = \pm 20V, V_{DS} = 0V$ teristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}, I_D = 250\mu A$ Gate to Source Threshold Voltage $I_D = 250\mu A$, referenced to $25^{\circ}C$ Temperature Coefficient $V_{GS} = 10V, I_D = 13.5A$ Static Drain to Source On Resistance $V_{GS} = 10V, I_D = 13.5A$ Forward Transconductance $V_{DD} = 5V, I_D = 13.5A$ Characteristics $V_{DS} = 20V, V_{GS} = 0V,$ Input Capacitance $V_{DS} = 20V, V_{GS} = 0V,$ Gate Resistance $f = 1MHz$ Characteristics $f = 1MHz$ Turn-On Delay Time $V_{DD} = 20V, I_D = 13.5A,$	ControlVGS = 0V, VDS = 32V, VGS = 420V, VDS = 0VGate to Source Leakage Current $V_{GS} = \pm 20V, V_{DS} = 0V$ teristicsGate to Source Threshold Voltage Temperature Coefficient $V_{GS} = V_{DS}, I_D = 250\muA$ 1.0Gate to Source Threshold Voltage Temperature Coefficient $I_D = 250\muA$, referenced to $25^{\circ}C$ 1.0Static Drain to Source On Resistance $V_{GS} = 10V, I_D = 13.5A$ VVor Caracteristics $V_{GS} = 10V, I_D = 13.5A$ 1.0Characteristics $V_{DD} = 5V, I_D = 13.5A$ 1.0Input Capacitance Gate Resistance $V_{DS} = 20V, V_{GS} = 0V, f = 10Hz$ 1.0Characteristics $f = 1MHz$ 1.0Turn-On Delay Time Rise Time $V_{DD} = 20V, I_D = 13.5A, f = 10Hz$ 1.0	ConstructionVGS = 0V, VDS = 32V, Gate to Source Leakage CurrentVGS = $\pm 20V, V_{DS} = 0V$ teristicsGate to Source Threshold VoltageVGS = $V_{DS}, I_D = 250\muA$ 1.02.0Gate to Source Threshold VoltageID = $250\muA$, referenced to $25^{\circ}C$ -6.6Temperature CoefficientVGS = $10V, I_D = 13.5A$ 4.7VGS = $10V, I_D = 13.5A$ 4.7VGS = $10V, I_D = 13.5A$ 6.4VGS = $10V, I_D = 13.5A, T_J = 125^{\circ}C$ 7.1Forward TransconductanceVDD = $5V, I_D = 13.5A$ 60CharacteristicsInput CapacitanceVDS = $20V, V_{GS} = 0V, f_D = 13.5A$ 80Gate Resistancef = $1MHz$ 2.7CharacteristicsTurn-On Delay TimeVDD = $20V, I_D = 13.5A, J_T = 125^{\circ}C$ Turn-On Delay Time12Rise TimeVDD = $20V, I_D = 13.5A, J_T = 125^{\circ}C$	Consistent V _{GS} = 0V, V _{DS} = 32V, 1 Zero Gate Voltage Drain Current $V_{GS} = 0V, V_{DS} = 32V,$ 1 Gate to Source Leakage Current $V_{GS} = \pm 20V, V_{DS} = 0V$ ± 100 teristics Gate to Source Threshold Voltage $V_{GS} = V_{DS}, I_D = 250\mu A$ 1.0 2.0 3.0 Gate to Source Threshold Voltage $I_D = 250\mu A$, referenced to 25° C -6.6 -6.6 Temperature Coefficient $I_D = 250\mu A$, referenced to 25° C -6.6 -6.6 Static Drain to Source On Resistance $V_{GS} = 10V, I_D = 13.5A$ 4.7 5.8 V_{GS} = 10V, I_D = 13.5A, T_J = 125^{\circ}C 7.1 9.3

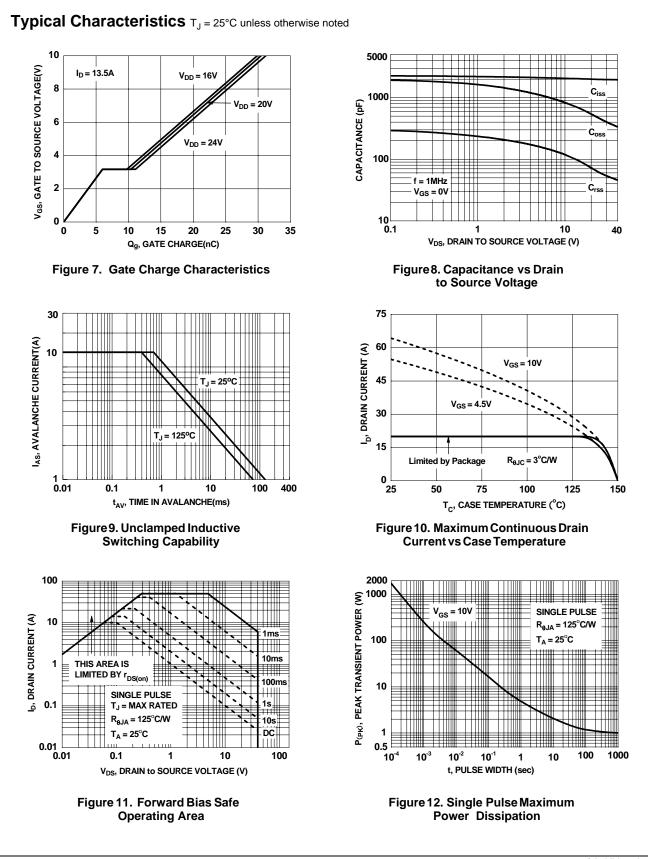
3. Starting $T_J = 25^{\circ}$ C; N-ch: L = 3 mH, I_{AS} = 12A, V_{DD} = 40V, V_{GS} = 10V

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FDMC8462 Rev.C

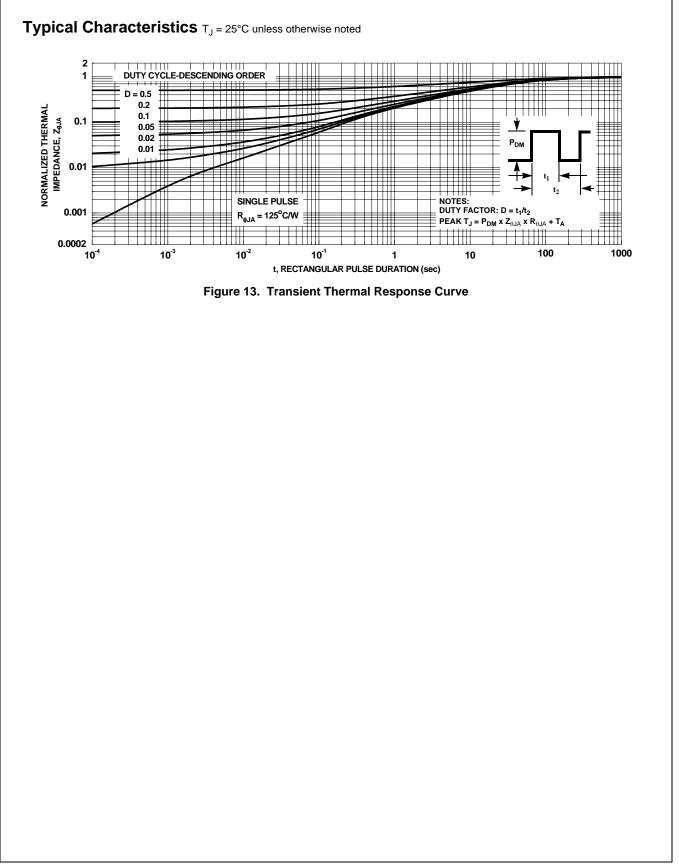
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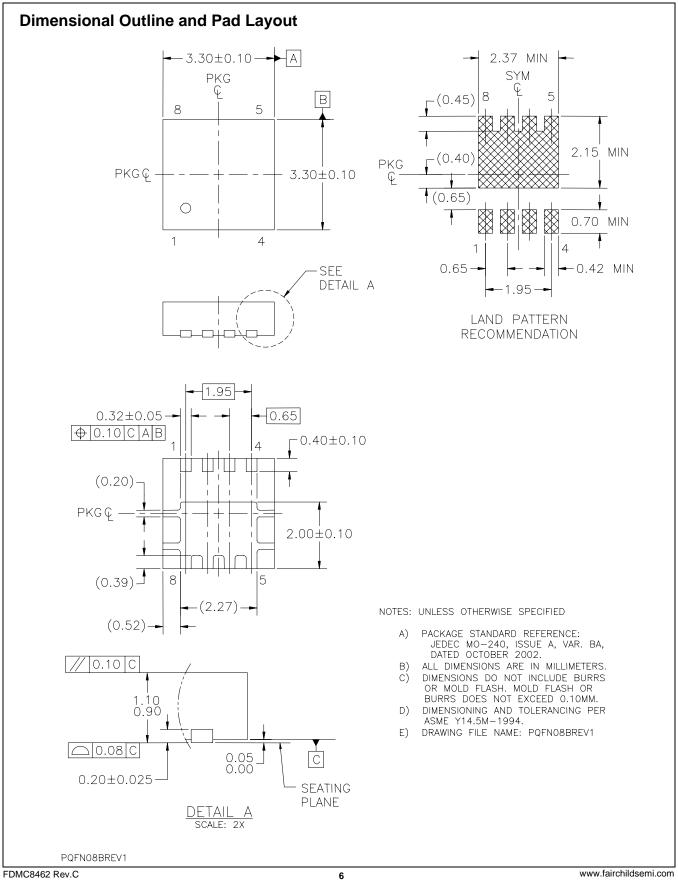
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